

General Description

This Super Junction MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for active power factor correction and switching mode power supplies.

Features

- 12A, 500V, RDS(on) = 0.37Ω @VGS = 10 V
- 100% avalanche tested
- Low Power Loss by High Speed Switching and Low On-Resistance

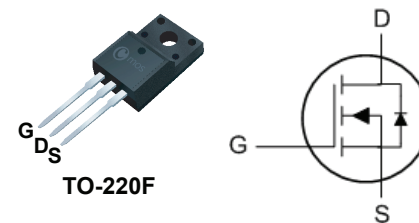
Product Summary

BVDSS	RDSON	ID
500V	0.37Ω	12A

Applications

- Power factor correction(PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible power supply(UPS)

TO-220F Pin Configuration



Type	Package	Marking
CMF50R380	TO-220F	CMF50R380

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DSS}	Drain-Source Voltage	500	V
I _D	Drain Current - Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	12	A
		7.2	A
I _{DM}	Drain Current - Pulsed	36	A
V _{GSS}	Gate-Source Voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy	40	mJ
dv/dt	Peak Diode Recovery dv/dt	20	V/ns
P _D	Power Dissipation (T _C = 25°C)	31	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8 from case for 5 seconds	300	°C

Thermal Characteristics

Symbol	Parameter	Rating	Units
R _{θJC}	Thermal Resistance, Junction-to-Case Max.	4	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient Max.	62	°C/W

Electrical Characteristic

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	500	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	μA
		$V_{DS} = 480\text{ V}, V_{GS} = 0\text{ V}, T_J = 125^\circ\text{C}$	--	--	10	
I _{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	--	--	± 100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2	--	4	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 4.5\text{ A}$	--	0.3	0.37	Ω

Dynamic Characteristics

C _{iss}	Input Capacitance	$V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	1300	--	pF
C _{oss}	Output Capacitance		--	30	--	pF
C _{rss}	Reverse Transfer Capacitance		--	2.5	--	pF

Switching Characteristics

t _{d(on)}	Turn-On Delay Time	$V_{DS} = 400\text{ V}, I_D = 5.5\text{ A}$ $R_G = 5\text{ }\Omega, V_{GS} = 10\text{ V}$	--	20	--	ns
t _r	Turn-On Rise Time		--	13	--	ns
t _{d(off)}	Turn-Off Delay Time		--	45	--	ns
t _f	Turn-Off Fall Time		--	16	--	ns
Q _g	Total Gate Charge	$V_{DS} = 480\text{ V}, I_D = 5.5\text{ A}$ $V_{GS} = 10\text{ V}$	--	20	--	nC
Q _{gs}	Gate-Source Charge		--	4.5	--	nC
Q _{gd}	Gate-Drain Charge		--	6.5	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current	--	--	12	A	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	36	A	
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 9\text{ A}$	--	--	1.4	V

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